IGBT for Automotive Application

1200 V, 25 A

AFGHL25T120RHD

Description

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop II Trench construction. Provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss, which is AEC Q101 qualified offer the optimum performance for both hard and soft switching topology in automotive application.

Features

- Extremely Efficient Trench with Field Stop Technology
- Maximum Junction Temperature: $T_J = 175^{\circ}C$
- Short Circuit Withstand Time 8 µs
- 100% of the Parts Tested for I_{LM} (Note 2)
- Fast Switching
- Tighten Parameter Distribution
- AEC-Q101 Qualified and PPAP Capable
- This Device is Pb–Free, Halogen Free/BFR Free and is RoHS Compliant

Typical Applications

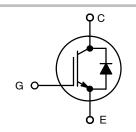
- Automotive HEV-EV e-compressor
- Automotive HEV–EV PTC heater
- Automotive HEV-EV Onboard Chargers
- Automotive HEV-EV DC-DC Converters

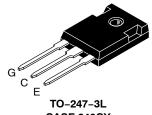


ON Semiconductor®

www.onsemi.com

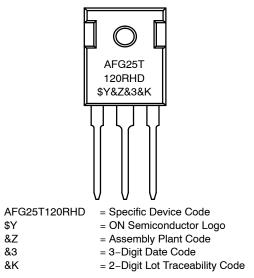
| V _{CES} | Ιc | V _{CE(Sat)} |
|------------------|------|----------------------|
| 1200 V | 25 A | 2.0 V (Typ.) |





CASE 340CX





ORDERING INFORMATION

| Device | Package | Shipping |
|----------------|-----------|-----------------|
| AFGHL25T120RHD | TO-247-3L | 30 Units / Rail |

MAXIMUM RATINGS

| Description | Symbol | Value | Units |
|---|----------------------------------|-------------|-------|
| Collector to Emitter Voltage | V _{CES} | 1200 | V |
| Gate to Emitter Voltage | V _{GES} | ±20 | V |
| Transient Gate to Emitter Voltage | | ±30 | |
| Collector Current @ $T_C = 25^{\circ}C$ (Note 1) | Ι _C | 48 | А |
| Collector Current @ T _C = 100°C | | 25 | |
| Pulsed Collector Current (Note 2) | I _{LM} | 100 | А |
| Pulsed Collector Current (Note 3) | I _{CM} | 100 | А |
| Diode Forward Current @ $T_C = 25^{\circ}C$ (Note 1) | l _F | 48 | А |
| Diode Forward Current @ T _C = 100°C | | 25 | |
| Pulsed Diode Maximum Forward Current | I _{FM} | 100 | А |
| Maximum Power Dissipation @ $T_C = 25^{\circ}C$ | PD | 261 | W |
| Maximum Power Dissipation @ T _C = 100°C | | 130 | - |
| Short Circuit Withstand Time V_{GE} = 15 V, V_{CE} = 600 V, T_{J} = 150°C | SCWT | 8 | μs |
| Operating Junction Temperature / Storage Temperature Range | T _{J,} T _{STG} | –55 to +175 | °C |
| Maximum Lead Temp. For Soldering Purposes, 1/8" from case for 5 seconds | TL | 260 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Value limited by bond wire. 2. $V_{CC} = 600 \text{ V}$, $V_{GE} = 15 \text{ V}$, $I_C = 100 \text{ A}$, $R_G = 15 \Omega$, Inductive Load, 100% Tested 3. Repetitive rating: pulse width limited by max. Junction temperature.

THERMAL CHARACTERISTICS

| Rating | Symbol | Max. | Units |
|---|-----------------------|------|-------|
| Thermal Resistance, Junction to Case, for IGBT | $R_{	ext{	heta}JC}$ | 0.57 | °C/W |
| Thermal Resistance, Junction to Case, Max for Diode | $R_{	ext{	heta}JC}$ | 0.63 | °C/W |
| Thermal Resistance, Junction to Ambient, Max | $R_{	extsf{	heta}JA}$ | 40 | °C/W |

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

| Parameter | Test Conditions | Symbol | Min. | Тур. | Max. | Unit |
|--|---|--------------------------------|------|------|------|------|
| OFF CHARACTERISTICS | | | | | | |
| Collector-emitter Breakdown Voltage, Gate-emitter Short-circuited | V _{GE} = 0 V, I _C = 1mA | BVCES | 1250 | - | - | V |
| Temperature Coefficient of Breakdown Voltage | $V_{GE} = 0 V$, $I_C = 1mA$ | $\Delta BV_{CES}/\Delta T_{J}$ | - | 1.3 | - | V/°C |
| Collector-emitter Cut-off Current, Gate-emitter Short-circuited | V_{GE} = 0 V, V_{CE} = V_{CES} | ICES | _ | - | 40 | μΑ |
| Gate Leakage Current, Collector-emitter Short-circuited | $V_{GE} = V_{GES}, V_{CE} = 0 V$ | IGES | - | - | ±400 | nA |
| ON CHARACTERISTICS | · | • | • | • | • | • |

| Gate-emitter Threshold Voltage | V_{GE} = V_{CE} , I_C = 25 mA | VGE(th) | 5.3 | 6.3 | 7.3 | V |
|--------------------------------------|---|----------|-----|--------------|----------|---|
| Collector-emitter Saturation Voltage | V_{GE} = 15 V, I _C = 25 A V _{GE} = 15 V, I _C = 25 A, T _J = 175°C | VCE(sat) | - | 1.84 2.29 | 2.4 _ | V |

ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise specified) (continued)

| Parameter | Test Conditions | Symbol | Min. | Тур. | Max. | Unit |
|-------------------------------|---|---------------------|------|--------------|----------|------|
| DYNAMIC CHARACTERISTICS | | | | | | |
| Input Capacitance | V_{CE} = 30 V, V_{GE} = 0 V, f = 1 MHz | Cies | - | 3920 | - | pF |
| Output Capacitance | | C _{oes} | - | 157 | - | |
| Reverse Transfer Capacitance | | C _{res} | - | 71 | - | |
| SWITCHING CHARACTERISTICS | | | | | | |
| Turn-on Delay Time | $T_{J} = 25^{\circ}C$ | t _{d(on)} | - | 26 | - | ns |
| Rise Time | $V_{CC} = 600 \text{ V}, \text{ I}_{C} = 12.5 \text{ A}$ Rg = 5 Ω | t _r | - | 10 | - | 1 |
| Turn-off Delay Time | V _{GE} = 15 V Inductive Load | t _{d(off)} | - | 133 | - | 1 |
| Fall Time | | t _f | - | 106 | - | 1 |
| Turn-on Switching Loss | | E _{on} | - | 0.9 | - | mJ |
| Turn-off Switching Loss | | E _{off} | - | 0.44 | - | 1 |
| Total Switching Loss | | E _{ts} | - | 1.34 | - | 1 |
| Turn-on Delay Time | $T_J = 25^{\circ}C$ | t _{d(on)} | - | 27 | - | ns |
| Rise Time | $V_{CC} = 600 \text{ V}, \text{ I}_{C} = 25 \text{ A}$ $\text{Rg} = 5 \Omega$ $V_{GE} = 15 \text{ V}$ Inductive Load | t _r | - | 16 | - | 1 |
| Turn-off Delay Time | | t _{d(off)} | - | 118 | - | 1 |
| Fall Time | | t _f | - | 101 | - | 1 |
| Turn-on Switching Loss | 1 | E _{on} | - | 1.94 | - | mJ |
| Turn-off Switching Loss | | E _{off} | - | 0.77 | - | |
| Total Switching Loss | | E _{ts} | - | 2.71 | - | 1 |
| Turn-on Delay Time | T _J = 175°C | t _{d(on)} | - | 24 | - | ns |
| Rise Time | | t _r | - | 12 | - | 1 |
| Turn-off Delay Time | V _{GE} = 15 V Inductive Load | t _{d(off)} | - | 156 | - | 1 |
| Fall Time | | t _f | - | 280 | - | 1 |
| Turn-on Switching Loss | | Eon | - | 1.42 | - | mJ |
| Turn-off Switching Loss | | E _{off} | - | 1.03 | - | 1 |
| Total Switching Loss | | E _{ts} | - | 2.45 | - | 1 |
| Turn-on Delay Time | T _J = 175°C | t _{d(on)} | - | 28 | - | ns |
| Rise Time | $V_{CC} = 600 \text{ V}, \text{ I}_{C} = 25 \text{ A}$ Rg = TBD | t _r | - | 16 | - | 1 |
| Turn-off Delay Time | V _{GE} = 15 V Inductive Load | t _{d(off)} | - | 132 | - | 1 |
| Fall Time | | t _f | - | 208 | - | 1 |
| Turn-on Switching Loss | | Eon | - | 2.87 | - | mJ |
| Turn-off Switching Loss | | E _{off} | - | 1.57 | - | 1 |
| Total Switching Loss | 7 | E _{ts} | - | 4.44 | - | 1 |
| Total Gate Charge | V_{CE} = 600 V, I _C = 25 A, V _{GE} = 15 V | Qg | - | 189 | - | nC |
| Gate to Emitter Charge | 7 | Q _{ge} | - | 33 | - | 1 |
| Gate to collector Charge | 7 | Q _{gc} | - | 97 | - | 1 |
| DIODE CHARACTERISTICS | | | - | - | - | - |
| Forward Voltage | $I_F = 25 \text{ A}, T_J = 25^{\circ}\text{C}$ $I_F = 25 \text{ A}, T_J = 175^{\circ}\text{C}$ | V _F | - | 1.43 1.44 | 2.0 _ | V |
| Reverse Recovery Energy | T _J = 25°C | E _{rec} | - | 0.46 | - | mJ |
| Diode Reverse Recovery Time | V _R = 600 V, I _F = 12.5 A, dI _F /dt = 1000 A/μs, | T _{rr} | - | 112 | - | ns |
| Diode Reverse Recovery Charge | | Q _{rr} | - | 1537 | - | nC |

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified) (continued)

| Parameter | Test Conditions | Symbol | Min. | Тур. | Max. | Unit |
|-------------------------------|--|------------------|------|------|------|------|
| DIODE CHARACTERISTICS | | | | | | |
| Reverse Recovery Energy | $\begin{array}{c} T_J = 25 ^{\circ}\text{C} \\ V_R = 600 \text{V}, I_F = 25 \text{A}, \\ dI_F/dt = 1000 \text{A}/\mu\text{s}, \end{array}$ | E _{rec} | - | 0.75 | - | mJ |
| Diode Reverse Recovery Time | | T _{rr} | - | 159 | - | ns |
| Diode Reverse Recovery Charge | | Q _{rr} | - | 2429 | - | nC |
| Reverse Recovery Energy | | E _{rec} | - | 1.13 | - | mJ |
| Diode Reverse Recovery Time | | T _{rr} | - | 185 | - | ns |
| Diode Reverse Recovery Charge | | Q _{rr} | - | 3241 | - | nC |
| Reverse Recovery Energy | T _J = 175°C | E _{rec} | - | 1.48 | - | mJ |
| Diode Reverse Recovery Time | | T _{rr} | - | 214 | - | ns |
| Diode Reverse Recovery Charge | | Q _{rr} | - | 4233 | - | nC |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS

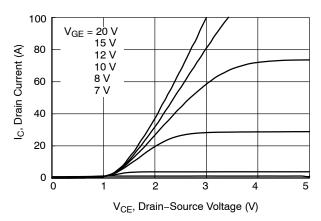


Figure 1. Typical Output Characteristics (25°C)

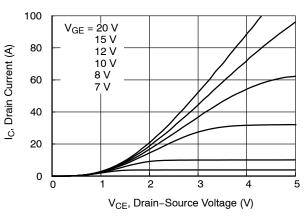


Figure 2. Typical Output Characteristics (175°C)

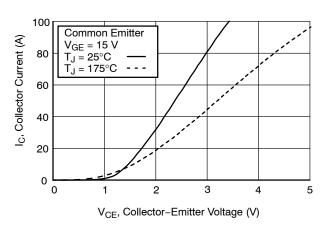


Figure 3. Typical Saturation Voltage Characteristics

20

18

16

14

12

10

8

6 4

2

0

0

5

12.5 A

25 A

50 A

V_{CE}, Collector-Emitter Voltage (V)

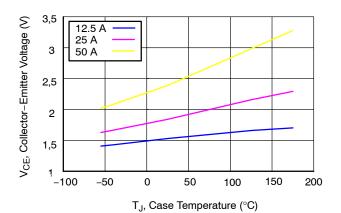


Figure 4. Saturation Voltage vs. Case Temperature at Variant Current Level

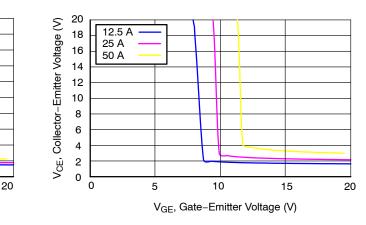


Figure 5. Saturation Voltage vs. V_{GE} (25°C)

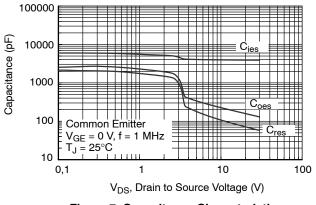
V_{GE}, Gate-Emitter Voltage (V)

10

15

Figure 6. Saturation Voltage vs. V_{GE} (175°C)

TYPICAL CHARACTERISTICS (continued)





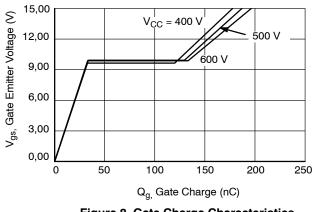


Figure 8. Gate Charge Characteristics

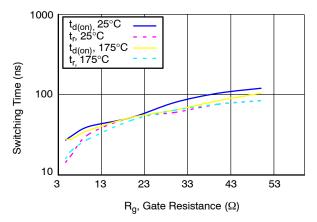


Figure 9. Turn-on Characteristics vs. Gate Resistance

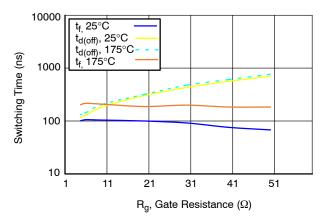


Figure 10. Turn-off Characteristics vs. Gate Resistance

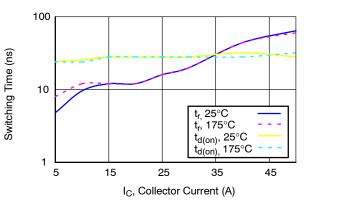


Figure 11. Turn-on Characteristics vs. Collector Current

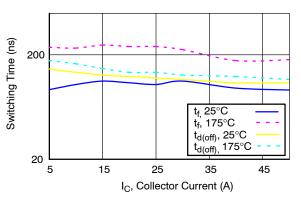


Figure 12. Turn-off Characteristics vs. Collector Current

TYPICAL CHARACTERISTICS (continued)

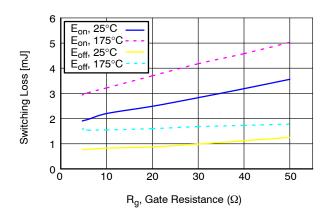


Figure 13. Switching Loss vs. Gate Resistance

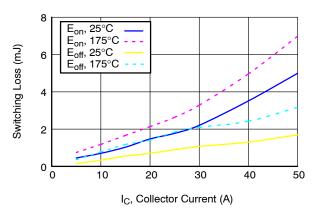


Figure 14. Switching Loss vs. Collector Current

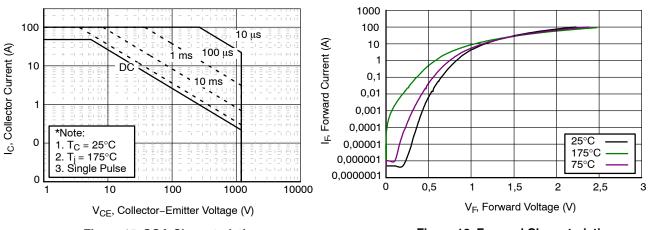
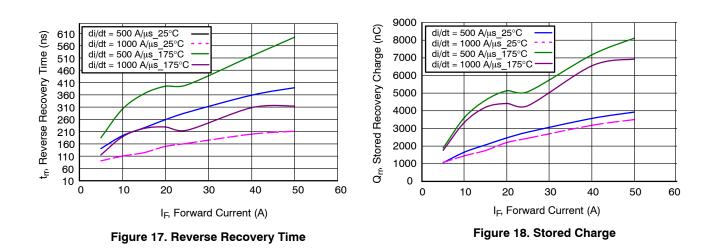


Figure 15. SOA Characteristics

Figure 16. Forward Characteristics



TYPICAL CHARACTERISTICS (continued)

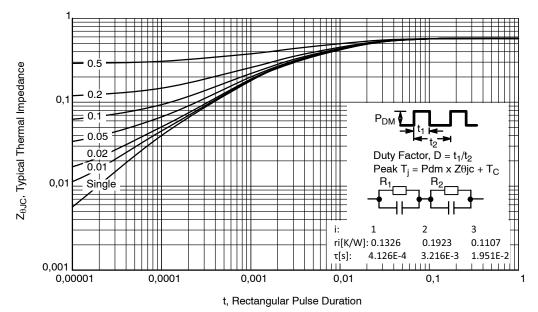
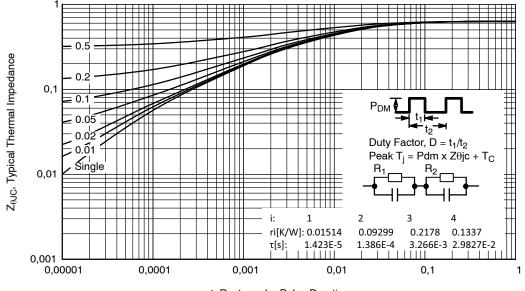
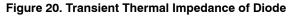


Figure 19. Transient Thermal Impedance of IGBT



t, Rectangular Pulse Duration



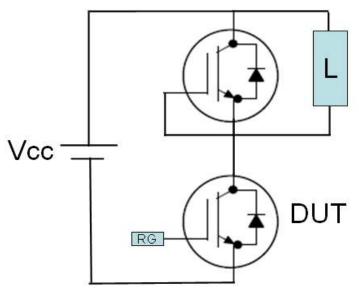
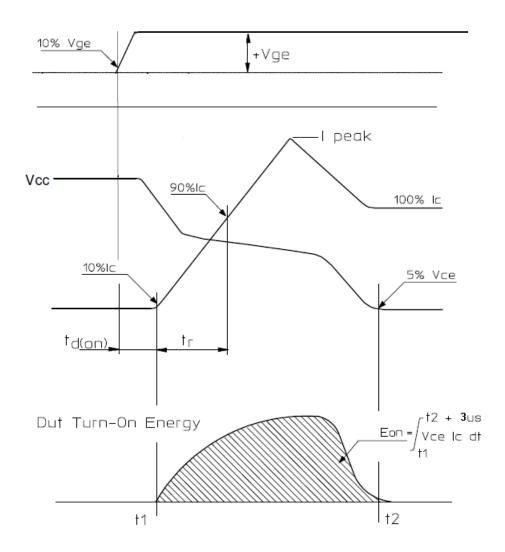
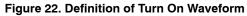


Figure 21. Test Circuit for Switching Characteristics





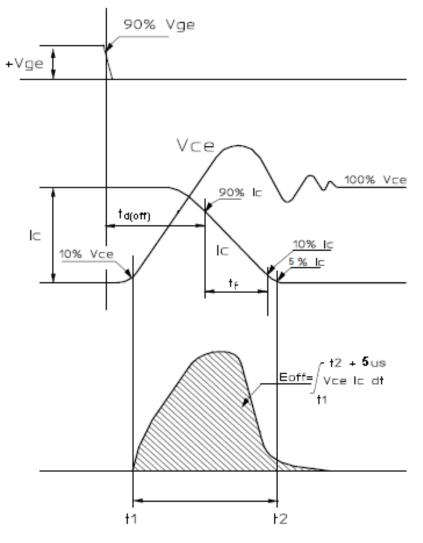
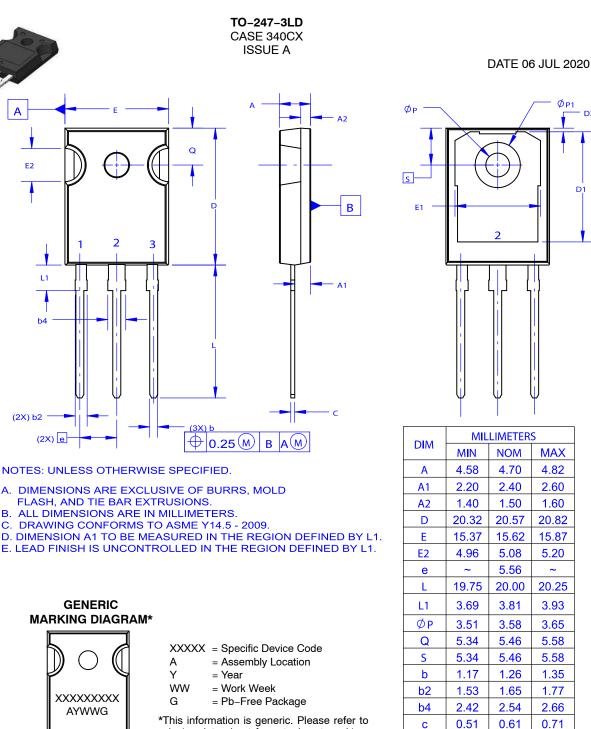


Figure 23. Definition of Turn Off Waveform



*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ", may or may not be present. Some products may not follow the Generic Marking.

С

D1

D2

E1

ØР1

13.08

0.51

12.81

6.60

~

0.93

~

6.80

| DOCUMENT NUMBER: | 98AON93302G | Electronic versions are uncontrolled except when accessed directly from the Document Repose Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. | | | |
|------------------|-------------|--|-------------|--|--|
| DESCRIPTION: | TO-247-3LD | | PAGE 1 OF 1 | | |

ON Semiconductor and 💷 are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

D2

D1

~

1.35

~

7.00

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at www.onsemi.com/support/sales